

QUALIFICATION REPORT

M28F512 512K (64K x 8) CMOS T5-U20 FLASH MEMORY in PLCC32

INTRODUCTION

The M28F512 is a 512K FLASH Memory organised as 64K x 8 bits. It is manufactured in the SGS-THOM-SON Advanced CMOS 0.8 micron T5-U20 (-20% upgrade) process which has been especially developed for flash memory products. The memory features a fast 100ns access time, very low standby power consumption of 100 μ A at 5V, an endurance of 10,000 Erase/Program cycles and an integrated Erase/Program Stop timer.

SGS-THOMSON recognises that the quality of a product must be built-in during the design, material procurement, manufacturing and testing. Also that the reliability must be demonstrated before the product is released to full mass production. The qualification of new products and the certification of new processes is a rigorous task undertaken by Quality and Reliability professionals, to ensure stable products and processes capable of fully meeting customer requirements.

A key step of this activity is the Design Review where we assure that,

- adequate and realistic product specifications have been developed;
- design and layout rules, as documented in the Design Rules Manual, have been respected;
- critical performance parameters and process variables have been identified;
- previously untested design techniques or manufacturing processes are recognised;
- manufacturability concerns are identified;
- comprehensive and efficient qualification programs are defined.

Product Qualification is made on all new products and on new packages. Qualification is also remade on existing products when there are major changes to the design or manufacturing. The tests performed are tailored to the parameters affected by the major change or to the combinations of new die or new package to be evaluated.

The results of the tests for the M28F512 FLASH Memory are on the attached pages of this qualification report.

Director of Memory Products Group Quality Control & Reliability

Atto Dande

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| Table 1. Product Qualification, Plastic Packages - Die Related Tests ⁽¹⁾ |
|---|
| M28F512, PLCC32, CMOS T5-U20 |

| Sub- group | Test Procedure | MIL-STD-883 Procedure | Test Condition s | Results | | | |
|---------------|--------------------------------------|--------------------------|---|---------|----------------------|------------------|------|
| | | | | Lots | Samp. | Fail | Note |
| 1 | Operating Life Test | 1005 | 140°C, V _{CC} = 7V, – 168 hrs – 500 hrs – 1000 hrs | | 320 115 115 | 0 0 0 | 4 |
| 2 | Retention Bake | 1008 | 150°C, – 168 hrs – 500 hrs – 1000 hrs – 2000 hrs | | 50 50 50 50 | 0 0 0 0 | |
| 3 | Retention Bake (after 10k cycles) | 1008 | 150°C, – 168 hrs | | 50 | 0 | |
| 4 | Write/Erase Cycling | | 10,000 cycles 20,000 cycles | | 50 50 | 0 0 | 2 |
| 5 | Temperature, Humidity, Bias | CECC 90,000 | 85°C, RH = 85%, V _{CC} = 5.5V, – 168 hrs – 500 hrs – 1000 hrs – 2000 hrs | | 61 61 61 61 | 0 0 0 0 | 4 |
| 6 | Temperature Cycling | 1010 | –65 to 150°C, – 500 cycles – 1000 cycles | | 64 64 | 0 0 | 4 |
| 7 | Thermal Shock | 1011 | –55 to 125°C, – 100 cycles – 500 cycles | | 34 34 | 0 0 | 4 |
| 8 | Pressure Pot | | 121°C, 2 Atm, – 96 hrs – 168 hrs – 240 hrs | | 68 68 68 | 0 0 0 | 4 |
| 9 | Pressure Pot | | 121°C, 2 Atm, – 96 hrs – 168 hrs – 240 hrs | | 68 68 68 | 0 0 0 | |
| 10 | Electrostatic Discharge | 3015 | 1500Ω, 100pF, 1750V | | 36 | 0 | |
| 11 | Electrostatic Discharge | EIAJ IC-121 | 0Ω, 200pF, 200V (min) | | | | 3 |
| 12 | Latch-up | JEDEC STD-17 | Current Injection 200mA (min), Overvoltage 14V/500mA (min) | | 45 | 0 | |

Notes: 1. Package qualified with another die version. Refer to the internal report: TR08-1992.
2. More information is available from the characterization of the test vehicle for this T5-U20 technology, the M28F101, refer to the latest Quality and Reliability Report (QRR).
3. Test not performed.
4. Samples previously submitted to preconditioning flow for Surface Mounting devices according to SGS-THOMSON specification.
5. Sample size decreased for capacity reasons.



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